

Welcome to [E-XFL.COM](http://E-XFL.COM)

### **Understanding Embedded - CPLDs (Complex Programmable Logic Devices)**

Embedded - CPLDs, or Complex Programmable Logic Devices, are highly versatile digital logic devices used in electronic systems. These programmable components are designed to perform complex logical operations and can be customized for specific applications. Unlike fixed-function ICs, CPLDs offer the flexibility to reprogram their configuration, making them an ideal choice for various embedded systems. They consist of a set of logic gates and programmable interconnects, allowing designers to implement complex logic circuits without needing custom hardware.

### **Applications of Embedded - CPLDs**

#### **Details**

Product Status	Active
Programmable Type	In System Programmable
Delay Time tpd(1) Max	2.5 ns
Voltage Supply - Internal	3V ~ 3.6V
Number of Logic Elements/Blocks	4
Number of Macrocells	64
Number of Gates	-
Number of I/O	32
Operating Temperature	0°C ~ 90°C (TJ)
Mounting Type	Surface Mount
Package / Case	48-LQFP
Supplier Device Package	48-TQFP (7x7)
Purchase URL	<a href="https://www.e-xfl.com/product-detail/lattice-semiconductor/lc4064v-25tn48c">https://www.e-xfl.com/product-detail/lattice-semiconductor/lc4064v-25tn48c</a>

- Block CLK2
- Block CLK3
- PT Clock
- PT Clock Inverted
- Shared PT Clock
- Ground

### Clock Enable Multiplexer

Each macrocell has a 4:1 clock enable multiplexer. This allows the clock enable signal to be selected from the following four sources:

- PT Initialization/CE
- PT Initialization/CE Inverted
- Shared PT Clock
- Logic High

### Initialization Control

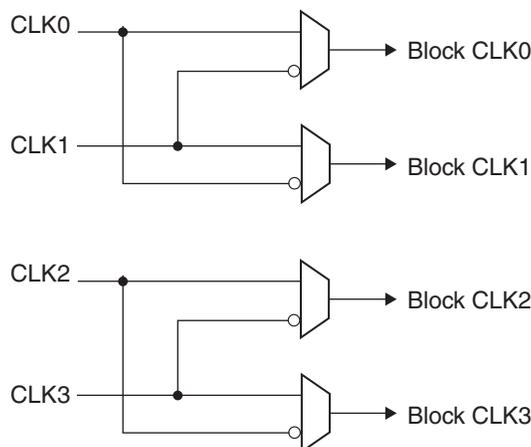
The ispMACH 4000 family architecture accommodates both block-level and macrocell-level set and reset capability. There is one block-level initialization term that is distributed to all macrocell registers in a GLB. At the macrocell level, two product terms can be “stolen” from the cluster associated with a macrocell to be used for set/reset functionality. A reset/preset swapping feature in each macrocell allows for reset and preset to be exchanged, providing flexibility.

Note that the reset/preset swapping selection feature affects power-up reset as well. All flip-flops power up to a known state for predictable system initialization. If a macrocell is configured to SET on a signal from the block-level initialization, then that macrocell will be SET during device power-up. If a macrocell is configured to RESET on a signal from the block-level initialization or is not configured for set/reset, then that macrocell will RESET on power-up. To guarantee initialization values, the  $V_{CC}$  rise must be monotonic, and the clock must be inactive until the reset delay time has elapsed.

### GLB Clock Generator

Each ispMACH 4000 device has up to four clock pins that are also routed to the GRP to be used as inputs. These pins drive a clock generator in each GLB, as shown in Figure 6. The clock generator provides four clock signals that can be used anywhere in the GLB. These four GLB clock signals can consist of a number of combinations of the true and complement edges of the global clock signals.

**Figure 6. GLB Clock Generator**



- LVTTTL
- LVC MOS 3.3
- LVC MOS 2.5
- LVC MOS 1.8
- 3.3V PCI Compatible

All of the I/Os and dedicated inputs have the capability to provide a bus-keeper latch, Pull-up Resistor or Pull-down Resistor. A fourth option is to provide none of these. The selection is done on a global basis. The default in both hardware and software is such that when the device is erased or if the user does not specify, the input structure is configured to be a Pull-up Resistor.

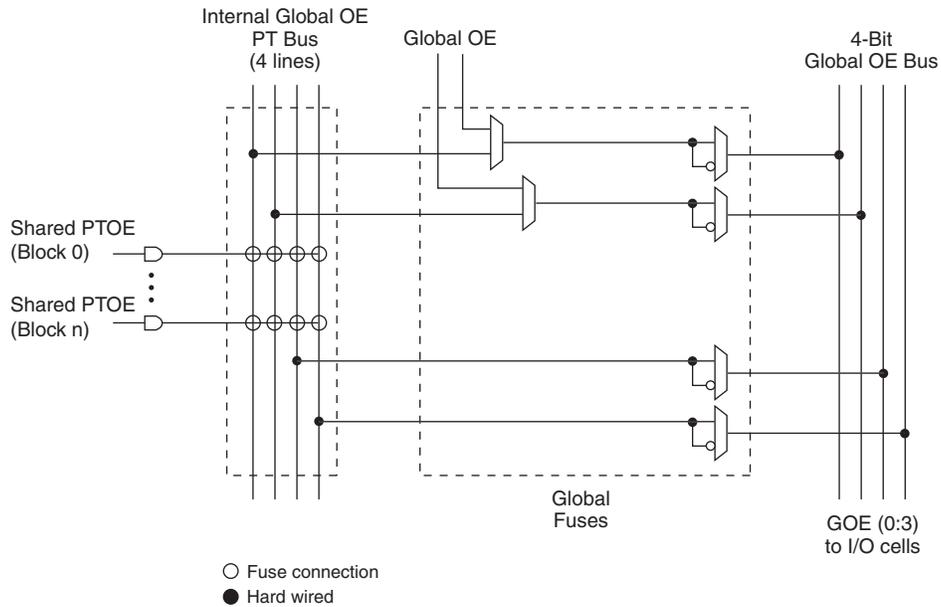
Each ispMACH 4000 device I/O has an individually programmable output slew rate control bit. Each output can be individually configured for fast slew or slow slew. The typical edge rate difference between fast and slow slew setting is 20%. For high-speed designs with long, unterminated traces, the slow-slew rate will introduce fewer reflections, less noise and keep ground bounce to a minimum. For designs with short traces or well terminated lines, the fast slew rate can be used to achieve the highest speed.

### Global OE Generation

Most ispMACH 4000 family devices have a 4-bit wide Global OE Bus, except the ispMACH 4032 device that has a 2-bit wide Global OE Bus. This bus is derived from a 4-bit internal global OE PT bus and two dual purpose I/O or GOE pins. Each signal that drives the bus can optionally be inverted.

Each GLB has a block-level OE PT that connects to all bits of the Global OE PT bus with four fuses. Hence, for a 256-macrocell device (with 16 blocks), each line of the bus is driven from 16 OE product terms. Figures 9 and 10 show a graphical representation of the global OE generation.

**Figure 9. Global OE Generation for All Devices Except ispMACH 4032**



### Supply Current, ispMACH 4000V/B/C (Cont.)

Over Recommended Operating Conditions

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
I <sub>CC</sub> <sup>4</sup>	Standby Power Supply Current	V <sub>CC</sub> = 3.3V	—	13	—	mA
		V <sub>CC</sub> = 2.5V	—	13	—	mA
		V <sub>CC</sub> = 1.8V	—	3	—	mA

1. T<sub>A</sub> = 25°C, frequency = 1.0 MHz.
2. Device configured with 16-bit counters.
3. I<sub>CC</sub> varies with specific device configuration and operating frequency.
4. T<sub>A</sub> = 25°C

### Supply Current, ispMACH 4000Z

Over Recommended Operating Conditions

Symbol	Parameter	Condition	Min.	Typ.	Max.	Units
<b>ispMACH 4032ZC</b>						
ICC <sup>1,2,3,5</sup>	Operating Power Supply Current	V <sub>CC</sub> = 1.8V, T <sub>A</sub> = 25°C	—	50	—	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 70°C	—	58	—	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 85°C	—	60	—	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 125°C	—	70	—	μA
ICC <sup>4,5</sup>	Standby Power Supply Current	V <sub>CC</sub> = 1.8V, T <sub>A</sub> = 25°C	—	10	—	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 70°C	—	13	20	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 85°C	—	15	25	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 125°C	—	22	—	μA
<b>ispMACH 4064ZC</b>						
ICC <sup>1,2,3,5</sup>	Operating Power Supply Current	V <sub>CC</sub> = 1.8V, T <sub>A</sub> = 25°C	—	80	—	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 70°C	—	89	—	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 85°C	—	92	—	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 125°C	—	109	—	μA
ICC <sup>4,5</sup>	Standby Power Supply Current	V <sub>CC</sub> = 1.8V, T <sub>A</sub> = 25°C	—	11	—	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 70°C	—	15	25	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 85°C	—	18	35	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 125°C	—	37	—	μA
<b>ispMACH 4128ZC</b>						
ICC <sup>1,2,3,5</sup>	Operating Power Supply Current	V <sub>CC</sub> = 1.8V, T <sub>A</sub> = 25°C	—	168	—	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 70°C	—	190	—	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 85°C	—	195	—	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 125°C	—	212	—	μA
ICC <sup>4,5</sup>	Standby Power Supply Current	V <sub>CC</sub> = 1.8V, T <sub>A</sub> = 25°C	—	12	—	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 70°C	—	16	35	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 85°C	—	19	50	μA
		V <sub>CC</sub> = 1.9V, T <sub>A</sub> = 125°C	—	42	—	μA

## ispMACH 4000V/B/C External Switching Characteristics (Cont.)

## Over Recommended Operating Conditions

Parameter	Description <sup>1, 2, 3</sup>	-5		-75		-10		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
t <sub>PD</sub>	5-PT bypass combinatorial propagation delay	—	5.0	—	7.5	—	10.0	ns
t <sub>PD_MC</sub>	20-PT combinatorial propagation delay through macrocell	—	5.5	—	8.0	—	10.5	ns
t <sub>S</sub>	GLB register setup time before clock	3.0	—	4.5	—	5.5	—	ns
t <sub>ST</sub>	GLB register setup time before clock with T-type register	3.2	—	4.7	—	5.5	—	ns
t <sub>SIR</sub>	GLB register setup time before clock, input register path	1.2	—	1.7	—	1.7	—	ns
t <sub>SIRZ</sub>	GLB register setup time before clock with zero hold	2.2	—	2.7	—	2.7	—	ns
t <sub>H</sub>	GLB register hold time after clock	0.0	—	0.0	—	0.0	—	ns
t <sub>HT</sub>	GLB register hold time after clock with T-type register	0.0	—	0.0	—	0.0	—	ns
t <sub>HIR</sub>	GLB register hold time after clock, input register path	1.0	—	1.0	—	1.0	—	ns
t <sub>HIRZ</sub>	GLB register hold time after clock, input register path with zero hold	0.0	—	0.0	—	0.0	—	ns
t <sub>CO</sub>	GLB register clock-to-output delay	—	3.4	—	4.5	—	6.0	ns
t <sub>R</sub>	External reset pin to output delay	—	6.3	—	9.0	—	10.5	ns
t <sub>RW</sub>	External reset pulse duration	2.0	—	4.0	—	4.0	—	ns
t <sub>P<sub>TOE/DIS</sub></sub>	Input to output local product term output enable/disable	—	7.0	—	9.0	—	10.5	ns
t <sub>G<sub>P<sub>TOE/DIS</sub></sub></sub>	Input to output global product term output enable/disable	—	9.0	—	10.3	—	12.0	ns
t <sub>G<sub>OE/DIS</sub></sub>	Global OE input to output enable/disable	—	5.0	—	7.0	—	8.0	ns
t <sub>CW</sub>	Global clock width, high or low	2.2	—	2.8	—	4.0	—	ns
t <sub>GW</sub>	Global gate width low (for low transparent) or high (for high transparent)	2.2	—	2.8	—	4.0	—	ns
t <sub>WIR</sub>	Input register clock width, high or low	2.2	—	2.8	—	4.0	—	ns
f <sub>MAX</sub> <sup>4</sup>	Clock frequency with internal feedback	—	227	—	168	—	125	MHz
f <sub>MAX</sub> (Ext.)	Clock frequency with external feedback, [1/ (t <sub>S</sub> + t <sub>CO</sub> )]	—	156	—	111	—	86	MHz

1. Timing numbers are based on default LVCMOS 1.8 I/O buffers. Use timing adjusters provided to calculate other standards.

Timing v.3.2

2. Measured using standard switching circuit, assuming GRP loading of 1 and 1 output switching.

3. Pulse widths and clock widths less than minimum will cause unknown behavior.

4. Standard 16-bit counter using GRP feedback.

## ispMACH 4000V/B/C Internal Timing Parameters

Over Recommended Operating Conditions

Parameter	Description	-2.5	-2.7	-3	-3.5	Units
<b>In/Out Delays</b>						
$t_{IN}$	Input Buffer Delay	—	0.60	—	0.60	ns
$t_{GOE}$	Global OE Pin Delay	—	2.04	—	2.54	ns
$t_{GCLK\_IN}$	Global Clock Input Buffer Delay	—	0.78	—	1.28	ns
$t_{BUF}$	Delay through Output Buffer	—	0.85	—	0.85	ns
$t_{EN}$	Output Enable Time	—	0.96	—	0.96	ns
$t_{DIS}$	Output Disable Time	—	0.96	—	0.96	ns
<b>Routing/GLB Delays</b>						
$t_{ROUTE}$	Delay through GRP	—	0.61	—	0.81	ns
$t_{MCELL}$	Macrocell Delay	—	0.45	—	0.55	ns
$t_{INREG}$	Input Buffer to Macrocell Register Delay	—	0.11	—	0.31	ns
$t_{FBK}$	Internal Feedback Delay	—	0.00	—	0.00	ns
$t_{PDb}$	5-PT Bypass Propagation Delay	—	0.44	—	0.44	ns
$t_{PDi}$	Macrocell Propagation Delay	—	0.64	—	0.64	ns
<b>Register/Latch Delays</b>						
$t_S$	D-Register Setup Time (Global Clock)	0.92	—	1.12	—	ns
$t_{S\_PT}$	D-Register Setup Time (Product Term Clock)	1.42	—	1.32	—	ns
$t_{ST}$	T-Register Setup Time (Global Clock)	1.12	—	1.32	—	ns
$t_{ST\_PT}$	T-Register Setup Time (Product Term Clock)	1.42	—	1.32	—	ns
$t_H$	D-Register Hold Time	0.88	—	0.68	—	ns
$t_{HT}$	T-Register Hold Time	0.88	—	0.68	—	ns
$t_{SIR}$	D-Input Register Setup Time (Global Clock)	0.82	—	1.37	—	ns
$t_{SIR\_PT}$	D-Input Register Setup Time (Product Term Clock)	1.45	—	1.45	—	ns
$t_{HIR}$	D-Input Register Hold Time (Global Clock)	0.88	—	0.63	—	ns
$t_{HIR\_PT}$	D-Input Register Hold Time (Product Term Clock)	0.88	—	0.63	—	ns
$t_{COi}$	Register Clock to Output/Feedback MUX Time	—	0.52	—	0.52	ns
$t_{CES}$	Clock Enable Setup Time	2.25	—	2.25	—	ns
$t_{CEH}$	Clock Enable Hold Time	1.88	—	1.88	—	ns
$t_{SL}$	Latch Setup Time (Global Clock)	0.92	—	1.12	—	ns
$t_{SL\_PT}$	Latch Setup Time (Product Term Clock)	1.42	—	1.32	—	ns
$t_{HL}$	Latch Hold Time	1.17	—	1.17	—	ns
$t_{GOi}$	Latch Gate to Output/Feedback MUX Time	—	0.33	—	0.33	ns

## ispMACH 4000Z Internal Timing Parameters

Over Recommended Operating Conditions

Parameter	Description	-35		-37		-42		Units
		Min.	Max.	Min.	Max.	Min.	Max.	
<b>In/Out Delays</b>								
t <sub>IN</sub>	Input Buffer Delay	—	0.75	—	0.80	—	0.75	ns
t <sub>GOE</sub>	Global OE Pin Delay	—	2.25	—	2.25	—	2.30	ns
t <sub>GCLK_IN</sub>	Global Clock Input Buffer Delay	—	1.60	—	1.60	—	1.95	ns
t <sub>BUF</sub>	Delay through Output Buffer	—	0.75	—	0.90	—	0.90	ns
t <sub>EN</sub>	Output Enable Time	—	2.25	—	2.25	—	2.50	ns
t <sub>DIS</sub>	Output Disable Time	—	1.35	—	1.35	—	2.50	ns
<b>Routing/GLB Delays</b>								
t <sub>ROUTE</sub>	Delay through GRP	—	1.60	—	1.60	—	2.15	ns
t <sub>MCELL</sub>	Macrocell Delay	—	0.65	—	0.75	—	0.85	ns
t <sub>INREG</sub>	Input Buffer to Macrocell Register Delay	—	0.91	—	1.00	—	1.00	ns
t <sub>FBK</sub>	Internal Feedback Delay	—	0.05	—	0.00	—	0.00	ns
t <sub>PDb</sub>	5-PT Bypass Propagation Delay	—	0.40	—	0.40	—	0.40	ns
t <sub>PDi</sub>	Macrocell Propagation Delay	—	0.25	—	0.25	—	0.65	ns
<b>Register/Latch Delays</b>								
t <sub>S</sub>	D-Register Setup Time (Global Clock)	0.80	—	0.95	—	0.90	—	ns
t <sub>S_PT</sub>	D-Register Setup Time (Product Term Clock)	1.35	—	1.95	—	1.90	—	ns
t <sub>ST</sub>	T-Register Setup Time (Global Clock)	1.00	—	1.15	—	1.10	—	ns
t <sub>ST_PT</sub>	T-register Setup Time (Product Term Clock)	1.55	—	1.75	—	2.10	—	ns
t <sub>H</sub>	D-Register Hold Time	1.40	—	1.55	—	1.80	—	ns
t <sub>HT</sub>	T-Register Hold Time	1.40	—	1.55	—	1.80	—	ns
t <sub>SIR</sub>	D-Input Register Setup Time (Global Clock)	0.94	—	0.90	—	1.50	—	ns
t <sub>SIR_PT</sub>	D-Input Register Setup Time (Product Term Clock)	1.45	—	1.45	—	1.45	—	ns
t <sub>HIR</sub>	D-Input Register Hold Time (Global Clock)	1.06	—	1.20	—	1.10	—	ns
t <sub>HIR_PT</sub>	D-Input Register Hold Time (Product Term Clock)	0.88	—	1.00	—	1.00	—	ns
t <sub>COi</sub>	Register Clock to Output/Feedback MUX Time	—	0.65	—	0.70	—	0.65	ns
t <sub>CES</sub>	Clock Enable Setup Time	1.00	—	2.00	—	2.00	—	ns
t <sub>CEH</sub>	Clock Enable Hold Time	0.00	—	0.00	—	0.00	—	ns
t <sub>SL</sub>	Latch Setup Time (Global Clock)	0.80	—	0.95	—	0.90	—	ns
t <sub>SL_PT</sub>	Latch Setup Time (Product Term Clock)	1.55	—	1.95	—	1.90	—	ns
t <sub>HL</sub>	Latch Hold Time	1.40	—	1.80	—	1.80	—	ns
t <sub>GOi</sub>	Latch Gate to Output/Feedback MUX Time	—	0.40	—	0.33	—	0.33	ns
t <sub>PDLi</sub>	Propagation Delay through Transparent Latch to Output/Feedback MUX	—	0.30	—	0.25	—	0.25	ns
t <sub>SRI</sub>	Asynchronous Reset or Set to Output/Feedback MUX Delay	—	0.28	—	0.28	—	1.27	ns
t <sub>SRR</sub>	Asynchronous Reset or Set Recovery Delay	—	2.00	—	1.67	—	1.80	ns
<b>Control Delays</b>								
t <sub>BCLK</sub>	GLB PT Clock Delay	—	1.30	—	1.50	—	1.55	ns
t <sub>PTCLK</sub>	Macrocell PT Clock Delay	—	1.50	—	1.70	—	1.55	ns
t <sub>BSR</sub>	GLB PT Set/Reset Delay	—	1.10	—	1.83	—	1.83	ns
t <sub>PTSR</sub>	Macrocell PT Set/Reset Delay	—	1.22	—	2.02	—	1.83	ns

ispMACH 4000V/B/C Timing Adders<sup>1</sup>

Adder Type	Base Parameter	Description	-25		-27		-3		-35		Units
			Min.	Max.	Min.	Max.	Min.	Max.	Min.	Max.	
<b>Optional Delay Adders</b>											
t <sub>INDIO</sub>	t <sub>INREG</sub>	Input register delay	—	0.95	—	1.00	—	1.00	—	1.00	ns
t <sub>EXP</sub>	t <sub>MCELL</sub>	Product term expander delay	—	0.33	—	0.33	—	0.33	—	0.33	ns
t <sub>ORP</sub>	—	Output routing pool delay	—	0.05	—	0.05	—	0.05	—	0.05	ns
t <sub>BLA</sub>	t <sub>ROUTE</sub>	Additional block loading adder	—	0.03	—	0.05	—	0.05	—	0.05	ns
<b>t<sub>IOI</sub> Input Adjusters</b>											
LVTTTL_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVTTTL standard	—	0.60	—	0.60	—	0.60	—	0.60	ns
LVC MOS33_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVC MOS 3.3 standard	—	0.60	—	0.60	—	0.60	—	0.60	ns
LVC MOS25_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVC MOS 2.5 standard	—	0.60	—	0.60	—	0.60	—	0.60	ns
LVC MOS18_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVC MOS 1.8 standard	—	0.00	—	0.00	—	0.00	—	0.00	ns
PCI_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using PCI compatible input	—	0.60	—	0.60	—	0.60	—	0.60	ns
<b>t<sub>IOO</sub> Output Adjusters</b>											
LVTTTL_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as TTL buffer	—	0.20	—	0.20	—	0.20	—	0.20	ns
LVC MOS33_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as 3.3V buffer	—	0.20	—	0.20	—	0.20	—	0.20	ns
LVC MOS25_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as 2.5V buffer	—	0.10	—	0.10	—	0.10	—	0.10	ns
LVC MOS18_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as 1.8V buffer	—	0.00	—	0.00	—	0.00	—	0.00	ns
PCI_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as PCI compatible buffer	—	0.20	—	0.20	—	0.20	—	0.20	ns
Slow Slew	t <sub>BUF</sub> , t <sub>EN</sub>	Output configured for slow slew rate	—	1.00	—	1.00	—	1.00	—	1.00	ns

Note: Open drain timing is the same as corresponding LVC MOS timing.

Timing v.3.2

1. Refer to TN1004, [ispMACH 4000 Timing Model Design and Usage Guidelines](#) for information regarding use of these adders.

ispMACH 4000Z Timing Adders <sup>1</sup>

Adder Type	Base Parameter	Description	-35		-37		-42		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
<b>Optional Delay Adders</b>									
t <sub>INDIO</sub>	t <sub>INREG</sub>	Input register delay	—	1.00	—	1.00	—	1.30	ns
t <sub>EXP</sub>	t <sub>MCELL</sub>	Product term expander delay	—	0.40	—	0.40	—	0.45	ns
t <sub>ORP</sub>	—	Output routing pool delay	—	0.40	—	0.40	—	0.40	ns
t <sub>BLA</sub>	t <sub>ROUTE</sub>	Additional block loading adder	—	0.04	—	0.05	—	0.05	ns
<b>t<sub>IOI</sub> Input Adjusters</b>									
LVTTTL_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVTTTL standard	—	0.60	—	0.60	—	0.60	ns
LVC MOS33_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVC MOS 3.3 standard	—	0.60	—	0.60	—	0.60	ns
LVC MOS25_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVC MOS 2.5 standard	—	0.60	—	0.60	—	0.60	ns
LVC MOS18_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVC MOS 1.8 standard	—	0.00	—	0.00	—	0.00	ns
PCI_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using PCI compatible input	—	0.60	—	0.60	—	0.60	ns
<b>t<sub>IOO</sub> Output Adjusters</b>									
LVTTTL_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as TTL buffer	—	0.20	—	0.20	—	0.20	ns
LVC MOS33_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as 3.3V buffer	—	0.20	—	0.20	—	0.20	ns
LVC MOS25_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as 2.5V buffer	—	0.10	—	0.10	—	0.10	ns
LVC MOS18_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as 1.8V buffer	—	0.00	—	0.00	—	0.00	ns
PCI_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as PCI compatible buffer	—	0.20	—	0.20	—	0.20	ns
Slow Slew	t <sub>BUF</sub> , t <sub>EN</sub>	Output configured for slow slew rate	—	1.00	—	1.00	—	1.00	ns

Note: Open drain timing is the same as corresponding LVC MOS timing.

Timing v.2.2

1. Refer to TN1004, [ispMACH 4000 Timing Model Design and Usage Guidelines](#) for information regarding the use of these adders.

ispMACH 4000Z Timing Adders (Cont.)<sup>1</sup>

Adder Type	Base Parameter	Description	-45		-5		-75		Units
			Min.	Max.	Min.	Max.	Min.	Max.	
<b>Optional Delay Adders</b>									
t <sub>INDIO</sub>	t <sub>INREG</sub>	Input register delay	—	1.30	—	1.30	—	1.30	ns
t <sub>EXP</sub>	t <sub>MCELL</sub>	Product term expander delay	—	0.45	—	0.45	—	0.50	ns
t <sub>ORP</sub>	—	Output routing pool delay	—	0.40	—	0.40	—	0.40	ns
t <sub>BLA</sub>	t <sub>ROUTE</sub>	Additional block loading adder	—	0.05	—	0.05	—	0.05	ns
<b>t<sub>IOI</sub> Input Adjusters</b>									
LVTTTL_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVTTTL standard	—	0.60	—	0.60	—	0.60	ns
LVC MOS33_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVC MOS 3.3 standard	—	0.60	—	0.60	—	0.60	ns
LVC MOS25_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVC MOS 2.5 standard	—	0.60	—	0.60	—	0.60	ns
LVC MOS18_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using LVC MOS 1.8 standard	—	0.00	—	0.00	—	0.00	ns
PCI_in	t <sub>IN</sub> , t <sub>GCLK_IN</sub> , t <sub>GOE</sub>	Using PCI compatible input	—	0.60	—	0.60	—	0.60	ns
<b>t<sub>IOO</sub> Output Adjusters</b>									
LVTTTL_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as TTL buffer	—	0.20	—	0.20	—	0.20	ns
LVC MOS33_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as 3.3V buffer	—	0.20	—	0.20	—	0.20	ns
LVC MOS25_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as 2.5V buffer	—	0.10	—	0.10	—	0.10	ns
LVC MOS18_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as 1.8V buffer	—	0.00	—	0.00	—	0.00	ns
PCI_out	t <sub>BUF</sub> , t <sub>EN</sub> , t <sub>DIS</sub>	Output configured as PCI compatible buffer	—	0.20	—	0.20	—	0.20	ns
Slow Slew	t <sub>BUF</sub> , t <sub>EN</sub>	Output configured for slow slew rate	—	1.00	—	1.00	—	1.00	ns

Note: Open drain timing is the same as corresponding LVC MOS timing.

Timing v.2.2

1. Refer to TN1004, [ispMACH 4000 Timing Model Design and Usage Guidelines](#) for information regarding use of these adders.

---

**Boundary Scan Waveforms and Timing Specifications**

Symbol	Parameter	Min.	Max.	Units
$t_{BTCP}$	TCK [BSCAN test] clock cycle	40	—	ns
$t_{BTCH}$	TCK [BSCAN test] pulse width high	20	—	ns
$t_{BTCL}$	TCK [BSCAN test] pulse width low	20	—	ns
$t_{BTSU}$	TCK [BSCAN test] setup time	8	—	ns
$t_{BTH}$	TCK [BSCAN test] hold time	10	—	ns
$t_{BRF}$	TCK [BSCAN test] rise and fall time	50	—	mV/ns
$t_{BTCO}$	TAP controller falling edge of clock to valid output	—	10	ns
$t_{BTOZ}$	TAP controller falling edge of clock to data output disable	—	10	ns
$t_{BTVO}$	TAP controller falling edge of clock to data output enable	—	10	ns
$t_{BTCPSU}$	BSCAN test Capture register setup time	8	—	ns
$t_{BTCPH}$	BSCAN test Capture register hold time	10	—	ns
$t_{BTUCO}$	BSCAN test Update reg, falling edge of clock to valid output	—	25	ns
$t_{BTUOZ}$	BSCAN test Update reg, falling edge of clock to output disable	—	25	ns
$t_{BTUOV}$	BSCAN test Update reg, falling edge of clock to output enable	—	25	ns

**ispMACH 4064V/B/C/Z, 4128V/B/C/Z, 4256V/B/C/Z Logic Signal Connections:  
100-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4064V/B/C/Z		ispMACH 4128V/B/C/Z		ispMACH 4256V/B/C/Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
42	1	C1	C^1	E2	E^1	I6	I^1
43	1	C2	C^2	E4	E^2	I10	I^2
44	1	C3	C^3	E6	E^3	I12	I^3
45	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
46	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
47	1	C4	C^4	E8	E^4	J2	J^0
48	1	C5	C^5	E10	E^5	J6	J^1
49	1	C6	C^6	E12	E^6	J10	J^2
50	1	C7	C^7	E14	E^7	J12	J^3
51	-	GND	-	GND	-	GND	-
52	-	TMS	-	TMS	-	TMS	-
53	1	C8	C^8	F0	F^0	K12	K^3
54	1	C9	C^9	F2	F^1	K10	K^2
55	1	C10	C^10	F4	F^2	K6	K^1
56	1	C11	C^11	F6	F^3	K2	K^0
57	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
58	1	C12	C^12	F8	F^4	L12	L^3
59	1	C13	C^13	F10	F^5	L10	L^2
60	1	C14	C^14	F12	F^6	L6	L^1
61	1	C15	C^15	F13	F^7	L4	L^0
62*	1	I	-	I	-	I	-
63	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
64	1	D15	D^15	G14	G^7	M4	M^0
65	1	D14	D^14	G12	G^6	M6	M^1
66	1	D13	D^13	G10	G^5	M10	M^2
67	1	D12	D^12	G8	G^4	M12	M^3
68	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
69	1	D11	D^11	G6	G^3	N2	N^0
70	1	D10	D^10	G5	G^2	N6	N^1
71	1	D9	D^9	G4	G^1	N10	N^2
72	1	D8	D^8	G2	G^0	N12	N^3
73*	1	I	-	I	-	I	-
74	-	TDO	-	TDO	-	TDO	-
75	-	VCC	-	VCC	-	VCC	-
76	-	GND	-	GND	-	GND	-
77*	1	I	-	I	-	I	-
78	1	D7	D^7	H13	H^7	O12	O^3
79	1	D6	D^6	H12	H^6	O10	O^2
80	1	D5	D^5	H10	H^5	O6	O^1
81	1	D4	D^4	H8	H^4	O2	O^0
82	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-

**ispMACH 4128V/B/C Logic Signal Connections: 128-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4128V/B/C	
		GLB/MC/Pad	ORP
19	0	C13	C^10
20	0	C12	C^9
21	0	C10	C^8
22	0	C9	C^7
23	0	C8	C^6
24	0	GND (Bank 0)	-
25	0	C6	C^5
26	0	C5	C^4
27	0	C4	C^3
28	0	C2	C^2
29	0	C0	C^0
30	0	VCCO (Bank 0)	-
31	0	TCK	-
32	0	VCC	-
33	0	GND	-
34	0	D14	D^11
35	0	D13	D^10
36	0	D12	D^9
37	0	D10	D^8
38	0	D9	D^7
39	0	D8	D^6
40	0	GND (Bank 0)	-
41	0	VCCO (Bank 0)	-
42	0	D6	D^5
43	0	D5	D^4
44	0	D4	D^3
45	0	D2	D^2
46	0	D1	D^1
47	0	D0	D^0
48	0	CLK1/I	-
49	1	GND (Bank 1)	-
50	1	CLK2/I	-
51	1	VCC	-
52	1	E0	E^0
53	1	E1	E^1
54	1	E2	E^2
55	1	E4	E^3
56	1	E5	E^4
57	1	E6	E^5
58	1	VCCO (Bank 1)	-
59	1	GND (Bank 1)	-
60	1	E8	E^6
61	1	E9	E^7

**ispMACH 4064Z, 4128Z and 4256Z Logic Signal Connections:  
132-Ball csBGA (Cont.)**

Ball Number	Bank Number	ispMACH 4064Z		ispMACH 4128Z		ispMACH 4256Z	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
P8	1	NC <sup>1</sup>	-	NC <sup>1</sup>	-	I <sup>1</sup>	-
M8	1	NC	-	E0	E <sup>0</sup>	I2	I <sup>1</sup>
P9	1	C0	C <sup>0</sup>	E1	E <sup>1</sup>	I4	I <sup>2</sup>
N9	1	C1	C <sup>1</sup>	E2	E <sup>2</sup>	I6	I <sup>3</sup>
M9	1	C2	C <sup>2</sup>	E4	E <sup>3</sup>	I8	I <sup>4</sup>
N10	1	C3	C <sup>3</sup>	E5	E <sup>4</sup>	I10	I <sup>5</sup>
P10	1	NC	-	E6	E <sup>5</sup>	I12	I <sup>6</sup>
M10	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
N11	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
P11	1	NC	-	E8	E <sup>6</sup>	J2	J <sup>1</sup>
M11	1	C4	C <sup>4</sup>	E9	E <sup>7</sup>	J4	J <sup>2</sup>
P12	1	C5	C <sup>5</sup>	E10	E <sup>8</sup>	J6	J <sup>3</sup>
N12	1	C6	C <sup>6</sup>	E12	E <sup>9</sup>	J8	J <sup>4</sup>
P13	1	C7	C <sup>7</sup>	E13	E <sup>10</sup>	J10	J <sup>5</sup>
P14	1	NC	-	E14	E <sup>11</sup>	J12	J <sup>6</sup>
N14	-	GND	-	GND	-	GND	-
N13	-	TMS	-	TMS	-	TMS	-
M14	1	NC	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
M12	1	NC	-	F0	F <sup>0</sup>	K12	K <sup>6</sup>
M13	1	C8	C <sup>8</sup>	F1	F <sup>1</sup>	K10	K <sup>5</sup>
L14	1	C9	C <sup>9</sup>	F2	F <sup>2</sup>	K8	K <sup>4</sup>
L12	1	C10	C <sup>10</sup>	F4	F <sup>3</sup>	K6	K <sup>3</sup>
L13	1	C11	C <sup>11</sup>	F5	F <sup>4</sup>	K4	K <sup>2</sup>
K14	1	NC	-	F6	F <sup>5</sup>	K2	K <sup>1</sup>
K13	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
K12	1	NC	-	F8	F <sup>6</sup>	L12	L <sup>6</sup>
J13	1	C12	C <sup>12</sup>	F9	F <sup>7</sup>	L10	L <sup>5</sup>
J14	1	C13	C <sup>13</sup>	F10	F <sup>8</sup>	L8	L <sup>4</sup>
J12	1	C14	C <sup>14</sup>	F12	F <sup>9</sup>	L6	L <sup>3</sup>
H14	1	C15	C <sup>15</sup>	F13	F <sup>10</sup>	L4	L <sup>2</sup>
H13	1	I	-	F14	F <sup>11</sup>	L2	L <sup>1</sup>
H12	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
G13	1	NC	-	G14	G <sup>11</sup>	M2	M <sup>1</sup>
G14	1	NC	-	G13	G <sup>10</sup>	M4	M <sup>2</sup>
G12	1	D15	D <sup>15</sup>	G12	G <sup>9</sup>	M6	M <sup>3</sup>
F14	1	D14	D <sup>14</sup>	G10	G <sup>8</sup>	M8	M <sup>4</sup>
F13	1	D13	D <sup>13</sup>	G9	G <sup>7</sup>	M10	M <sup>5</sup>
F12	1	D12	D <sup>12</sup>	G8	G <sup>6</sup>	M12	M <sup>6</sup>
E13	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
E14	1	NC	-	G6	G <sup>5</sup>	N2	N <sup>1</sup>
E12	1	D11	D <sup>11</sup>	G5	G <sup>4</sup>	N4	N <sup>2</sup>

**ispMACH 4256V/B/C/Z, 4384V/B/C, 4512V/B/C, Logic Signal Connections:  
176-Pin TQFP (Cont.)**

Pin Number	Bank Number	ispMACH 4256V/B/C/Z		ispMACH 4384V/B/C		ispMACH 4512V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
142	1	O0	O <sup>0</sup>	GX0	GX <sup>0</sup>	OX0	OX <sup>0</sup>
143	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
144	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
145	1	P14	P <sup>7</sup>	HX14	HX <sup>7</sup>	PX14	PX <sup>7</sup>
146	1	P12	P <sup>6</sup>	HX12	HX <sup>6</sup>	PX12	PX <sup>6</sup>
147	1	P10	P <sup>5</sup>	HX10	HX <sup>5</sup>	PX10	PX <sup>5</sup>
148	1	P8	P <sup>4</sup>	HX8	HX <sup>4</sup>	PX8	PX <sup>4</sup>
149	1	P6	P <sup>3</sup>	HX6	HX <sup>3</sup>	PX6	PX <sup>3</sup>
150	1	P4	P <sup>2</sup>	HX4	HX <sup>2</sup>	PX4	PX <sup>2</sup>
151	1	P2/GOE1	P <sup>1</sup>	HX2/GOE1	HX <sup>1</sup>	PX2/GOE1	PX <sup>1</sup>
152	1	P0	P <sup>0</sup>	HX0	HX <sup>0</sup>	PX0	PX <sup>0</sup>
153	-	GND	-	GND	-	GND	-
154	1	CLK3/I	-	CLK3/I	-	CLK3/I	-
155	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
156	0	CLK0/I	-	CLK0/I	-	CLK0/I	-
157	-	VCC	-	VCC	-	VCC	-
158	0	A0	A <sup>0</sup>	A0	A <sup>0</sup>	A0	A <sup>0</sup>
159	0	A2/GOE0	A <sup>1</sup>	A2/GOE0	A <sup>1</sup>	A2/GOE0	A <sup>1</sup>
160	0	A4	A <sup>2</sup>	A4	A <sup>2</sup>	A4	A <sup>2</sup>
161	0	A6	A <sup>3</sup>	A6	A <sup>3</sup>	A6	A <sup>3</sup>
162	0	A8	A <sup>4</sup>	A8	A <sup>4</sup>	A8	A <sup>4</sup>
163	0	A10	A <sup>5</sup>	A10	A <sup>5</sup>	A10	A <sup>5</sup>
164	0	A12	A <sup>6</sup>	A12	A <sup>6</sup>	A12	A <sup>6</sup>
165	0	A14	A <sup>7</sup>	A14	A <sup>7</sup>	A14	A <sup>7</sup>
166	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
167	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
168	0	B0	B <sup>0</sup>	B0	B <sup>0</sup>	B0	B <sup>0</sup>
169	0	B2	B <sup>1</sup>	B2	B <sup>1</sup>	B2	B <sup>1</sup>
170	0	B4	B <sup>2</sup>	B4	B <sup>2</sup>	B4	B <sup>2</sup>
171	0	B6	B <sup>3</sup>	B6	B <sup>3</sup>	B6	B <sup>3</sup>
172	0	B8	B <sup>4</sup>	B8	B <sup>4</sup>	B8	B <sup>4</sup>
173	0	B10	B <sup>5</sup>	B10	B <sup>5</sup>	B10	B <sup>5</sup>
174	0	B12	B <sup>6</sup>	B12	B <sup>6</sup>	B12	B <sup>6</sup>
175	0	B14	B <sup>7</sup>	B14	B <sup>7</sup>	B14	B <sup>7</sup>
176	-	VCC	-	VCC	-	VCC	-

**ispMACH 4256V/B/C, 4384V/B/C, 4512V/B/C Logic Signal Connections:  
256-Ball ftBGA/fpBGA (Cont.)**

Ball Number	I/O Bank	ispMACH 4256V/B/C 128-I/O		ispMACH 4256V/B/C 160-I/O		ispMACH 4384V/B/C		ispMACH 4512V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
H15	1	M2	M^1	M1	M^1	DX2	DX^1	JX2	JX^1
H14	1	M4	M^2	M2	M^2	DX4	DX^2	JX4	JX^2
H13	1	M6	M^3	M4	M^3	DX6	DX^3	JX6	JX^3
G16	1	M8	M^4	M6	M^4	DX8	DX^4	JX8	JX^4
H12	1	M10	M^5	M8	M^5	DX10	DX^5	JX10	JX^5
G15	1	M12	M^6	M9	M^6	DX12	DX^6	JX12	JX^6
H11	1	M14	M^7	M10	M^7	DX14	DX^7	JX14	JX^7
F16	1	NC	-	M12	M^8	CX0	CX^0	IX0	IX^0
G13	1	NC	-	M14	M^9	CX2	CX^1	IX4	IX^1
G14	1	NC	-	NC	-	EX14	EX^7	KX0	KX^0
F15	1	NC	-	NC	-	EX12	EX^6	KX2	KX^1
E16	1	NC	-	NC	-	NC	-	KX4	KX^2
-	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
-	1	-	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
E15	1	NC	-	NC	-	NC	-	KX6	KX^3
G12	1	NC	-	NC	-	EX10	EX^5	KX8	KX^4
E13	1	NC	-	NC	-	EX8	EX^4	KX10	KX^5
D16	1	NC	-	N0	N^0	CX4	CX^2	IX8	IX^2
E14	1	NC	-	N1	N^1	CX6	CX^3	IX12	IX^3
G11	1	N0	N^0	N2	N^2	FX0	FX^0	NX0	NX^0
D15	1	N2	N^1	N4	N^3	FX2	FX^1	NX2	NX^1
F11	1	N4	N^2	N6	N^4	FX4	FX^2	NX4	NX^2
C16	1	N6	N^3	N8	N^5	FX6	FX^3	NX6	NX^3
F12	1	N8	N^4	N9	N^6	FX8	FX^4	NX8	NX^4
D14	1	N10	N^5	N10	N^7	FX10	FX^5	NX10	NX^5
C15	1	N12	N^6	N12	N^8	FX12	FX^6	NX12	NX^6
B16	1	N14	N^7	N14	N^9	FX14	FX^7	NX14	NX^7
-	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
C14	-	TDO	-	TDO	-	TDO	-	TDO	-
-	-	VCC	-	VCC	-	VCC	-	VCC	-
-	-	GND	-	GND	-	GND	-	GND	-
-	1	-	-	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
A15	1	NC	-	NC	-	EX6	EX^3	KX12	KX^6
B14	1	NC	-	NC	-	EX4	EX^2	KX14	KX^7
E12	1	O14	O^7	O14	O^9	GX14	GX^7	OX14	OX^7
A14	1	O12	O^6	O12	O^8	GX12	GX^6	OX12	OX^6
C13	1	O10	O^5	O10	O^7	GX10	GX^5	OX10	OX^5
D13	1	O8	O^4	O9	O^6	GX8	GX^4	OX8	OX^4
E11	1	O6	O^3	O8	O^5	GX6	GX^3	OX6	OX^3
B13	1	O4	O^2	O6	O^4	GX4	GX^2	OX4	OX^2
F10	1	O2	O^1	O4	O^3	GX2	GX^1	OX2	OX^1

**ispMACH 4256V/B/C, 4384V/B/C, 4512V/B/C Logic Signal Connections:  
256-Ball ftBGA/fpBGA (Cont.)**

Ball Number	I/O Bank	ispMACH 4256V/B/C 128-I/O		ispMACH 4256V/B/C 160-I/O		ispMACH 4384V/B/C		ispMACH 4512V/B/C	
		GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP	GLB/MC/Pad	ORP
C12	1	O0	O^0	O2	O^2	GX0	GX^0	OX0	OX^0
E10	1	NC	-	O1	O^1	CX8	CX^4	MX0	MX^0
A13	1	NC	-	O0	O^0	CX10	CX^5	MX4	MX^1
D12	1	NC	-	NC	-	NC	-	LX0	LX^0
-	1	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-	GND (Bank 1)	-
-	1	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-	VCCO (Bank 1)	-
B12	1	NC	-	NC	-	NC	-	LX4	LX^1
A12	1	NC	-	NC	-	EX2	EX^1	LX8	LX^2
B11	1	NC	-	NC	-	EX0	EX^0	LX12	LX^3
A11	1	NC	-	P14	P^9	CX12	CX^6	MX8	MX^2
D10	1	NC	-	P12	P^8	CX14	CX^7	MX12	MX^3
C10	1	P14	P^7	P10	P^7	HX14	HX^7	PX14	PX^7
B10	1	P12	P^6	P9	P6	HX12	HX^6	PX12	PX^6
A10	1	P10	P^5	P8	P^5	HX10	HX^5	PX10	PX^5
A9	1	P8	P^4	P6	P^4	HX8	HX^4	PX8	PX^4
F9	1	P6	P^3	P4	P^3	HX6	HX^3	PX6	PX^3
B9	1	P4	P^2	P2	P^2	HX4	HX^2	PX4	PX^2
E9	1	P2/GOE1	P^1	P1/GOE1	P^1	HX2/GOE1	HX^1	PX2/GOE1	PX^1
C9	1	P0	P^0	P0	P^0	HX0	HX^0	PX0	PX^0
-	-	GND	-	GND	-	GND	-	GND	-
D9	1	CLK3/I	-	CLK3/I	-	CLK3/I	-	CLK3/I	-
-	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
B8	0	CLK0/I	-	CLK0/I	-	CLK0/I	-	CLK0/I	-
-	-	VCC	-	VCC	-	VCC	-	VCC	-
D8	0	A0	A^0	A0	A^0	A0	A^0	A0	A^0
C8	0	A2/GOE0	A^1	A1/GOE0	A^1	A2/GOE0	A^1	A2/GOE0	A^1
A8	0	A4	A^2	A2	A^2	A4	A^2	A4	A^2
A7	0	A6	A^3	A4	A^3	A6	A^3	A6	A^3
B7	0	A8	A^4	A6	A^4	A8	A^4	A8	A^4
E8	0	A10	A^5	A8	A^5	A10	A^5	A10	A^5
D7	0	A12	A^6	A9	A^6	A12	A^6	A12	A^6
F8	0	A14	A^7	A10	A^7	A14	A^7	A14	A^7
C7	0	NC	-	A12	A^8	F14	F^7	D0	D^0
A6	0	NC	-	A14	A^9	F12	F^6	D4	D^1
B6	0	NC	-	NC	-	D14	D^7	E0	E^0
A5	0	NC	-	NC	-	D12	D^6	E4	E^1
B5	0	NC	-	NC	-	NC	-	E8	E^2
-	0	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-	VCCO (Bank 0)	-
-	0	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-	GND (Bank 0)	-
D5	0	NC	-	NC	-	NC	-	E12	E^3
A4	0	NC	-	B0	B^0	F10	F^5	D8	D^2

## ispMACH 4000C (1.8V) Industrial Devices

Family	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4032C	LC4032C-5T48I	32	1.8	5	TQFP	48	32	I
	LC4032C-75T48I	32	1.8	7.5	TQFP	48	32	I
	LC4032C-10T48I	32	1.8	10	TQFP	48	32	I
	LC4032C-5T44I	32	1.8	5	TQFP	44	30	I
	LC4032C-75T44I	32	1.8	7.5	TQFP	44	30	I
	LC4032C-10T44I	32	1.8	10	TQFP	44	30	I
LC4064C	LC4064C-5T100I	64	1.8	5	TQFP	100	64	I
	LC4064C-75T100I	64	1.8	7.5	TQFP	100	64	I
	LC4064C-10T100I	64	1.8	10	TQFP	100	64	I
	LC4064C-5T48I	64	1.8	5	TQFP	48	32	I
	LC4064C-75T48I	64	1.8	7.5	TQFP	48	32	I
	LC4064C-10T48I	64	1.8	10	TQFP	48	32	I
	LC4064C-5T44I	64	1.8	5	TQFP	44	30	I
	LC4064C-75T44I	64	1.8	7.5	TQFP	44	30	I
LC4128C	LC4128C-5T128I	128	1.8	5	TQFP	128	92	I
	LC4128C-75T128I	128	1.8	7.5	TQFP	128	92	I
	LC4128C-10T128I	128	1.8	10	TQFP	128	92	I
	LC4128C-5T100I	128	1.8	5	TQFP	100	64	I
	LC4128C-75T100I	128	1.8	7.5	TQFP	100	64	I
	LC4128C-10T100I	128	1.8	10	TQFP	100	64	I
LC4256C	LC4256C-5FT256AI	256	1.8	5	ftBGA	256	128	I
	LC4256C-75FT256AI	256	1.8	7.5	ftBGA	256	128	I
	LC4256C-10FT256AI	256	1.8	10	ftBGA	256	128	I
	LC4256C-5FT256BI	256	1.8	5	ftBGA	256	160	I
	LC4256C-75FT256BI	256	1.8	7.5	ftBGA	256	160	I
	LC4256C-10FT256BI	256	1.8	10	ftBGA	256	160	I
	LC4256C-5F256AI <sup>1</sup>	256	1.8	5	fpBGA	256	128	I
	LC4256C-75F256AI <sup>1</sup>	256	1.8	7.5	fpBGA	256	128	I
	LC4256C-10F256AI <sup>1</sup>	256	1.8	10	fpBGA	256	128	I
	LC4256C-5F256BI <sup>1</sup>	256	1.8	5	fpBGA	256	160	I
	LC4256C-75F256BI <sup>1</sup>	256	1.8	7.5	fpBGA	256	160	I
	LC4256C-10F256BI <sup>1</sup>	256	1.8	10	fpBGA	256	160	I
	LC4256C-5T176I	256	1.8	5	TQFP	176	128	I
	LC4256C-75T176I	256	1.8	7.5	TQFP	176	128	I
	LC4256C-10T176I	256	1.8	10	TQFP	176	128	I
	LC4256C-5T100I	256	1.8	5	TQFP	100	64	I
	LC4256C-75T100I	256	1.8	7.5	TQFP	100	64	I
	LC4256C-10T100I	256	1.8	10	TQFP	100	64	I

## ispMACH 4000V (3.3V) Industrial Devices (Cont.)

Family	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4256V	LC4256V-5FT256AI	256	3.3	5	ftBGA	256	128	I
	LC4256V-75FT256AI	256	3.3	7.5	ftBGA	256	128	I
	LC4256V-10FT256AI	256	3.3	10	ftBGA	256	128	I
	LC4256V-5FT256BI	256	3.3	5	ftBGA	256	160	I
	LC4256V-75FT256BI	256	3.3	7.5	ftBGA	256	160	I
	LC4256V-10FT256BI	256	3.3	10	ftBGA	256	160	I
	LC4256V-5F256AI <sup>1</sup>	256	3.3	5	fpBGA	256	128	I
	LC4256V-75F256AI <sup>1</sup>	256	3.3	7.5	fpBGA	256	128	I
	LC4256V-10F256AI <sup>1</sup>	256	3.3	10	fpBGA	256	128	I
	LC4256V-5F256BI <sup>1</sup>	256	3.3	5	fpBGA	256	160	I
	LC4256V-75F256BI <sup>1</sup>	256	3.3	7.5	fpBGA	256	160	I
	LC4256V-10F256BI <sup>1</sup>	256	3.3	10	fpBGA	256	160	I
	LC4256V-5T176I	256	3.3	5	TQFP	176	128	I
	LC4256V-75T176I	256	3.3	7.5	TQFP	176	128	I
	LC4256V-10T176I	256	3.3	10	TQFP	176	128	I
	LC4256V-5T144I	256	3.3	5	TQFP	144	96	I
	LC4256V-75T144I	256	3.3	7.5	TQFP	144	96	I
	LC4256V-10T144I	256	3.3	10	TQFP	144	96	I
	LC4256V-5T100I	256	3.3	5	TQFP	100	64	I
	LC4256V-75T100I	256	3.3	7.5	TQFP	100	64	I
LC4256V-10T100I	256	3.3	10	TQFP	100	64	I	
LC4384V	LC4384V-5FT256I	384	3.3	5	ftBGA	256	192	I
	LC4384V-75FT256I	384	3.3	7.5	ftBGA	256	192	I
	LC4384V-10FT256I	384	3.3	10	ftBGA	256	192	I
	LC4384V-5F256I <sup>1</sup>	384	3.3	5	fpBGA	256	192	I
	LC4384V-75F256I <sup>1</sup>	384	3.3	7.5	fpBGA	256	192	I
	LC4384V-10F256I <sup>1</sup>	384	3.3	10	fpBGA	256	192	I
	LC4384V-5T176I	384	3.3	5	TQFP	176	128	I
	LC4384V-75T176I	384	3.3	7.5	TQFP	176	128	I
	LC4384V-10T176I	384	3.3	10	TQFP	176	128	I
LC4512V	LC4512V-5FT256I	512	3.3	5	ftBGA	256	208	I
	LC4512V-75FT256I	512	3.3	7.5	ftBGA	256	208	I
	LC4512V-10FT256I	512	3.3	10	ftBGA	256	208	I
	LC4512V-5F256I <sup>1</sup>	512	3.3	5	fpBGA	256	208	I
	LC4512V-75F256I <sup>1</sup>	512	3.3	7.5	fpBGA	256	208	I
	LC4512V-10F256I <sup>1</sup>	512	3.3	10	fpBGA	256	208	I
	LC4512V-5T176I	512	3.3	5	TQFP	176	128	I
	LC4512V-75T176I	512	3.3	7.5	TQFP	176	128	I
	LC4512V-10T176I	512	3.3	10	TQFP	176	128	I

1. Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.

## ispMACH 4000V (3.3V) Extended Temperature Devices

Device	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4032V	LC4032V-75T48E	32	3.3	7.5	TQFP	48	32	E
	LC4032V-75T44E	32	3.3	7.5	TQFP	44	30	E
LC4064V	LC4064V-75T100E	64	3.3	7.5	TQFP	100	64	E
	LC4064V-75T48E	64	3.3	7.5	TQFP	48	32	E
	LC4064V-75T44E	64	3.3	7.5	TQFP	44	30	E
LC4128V	LC4128V-75T144E	128	3.3	7.5	TQFP	144	96	E
	LC4128V-75T128E	128	3.3	7.5	TQFP	128	92	E
	LC4128V-75T100E	128	3.3	7.5	TQFP	100	64	E
LC4256V	LC4256V-75T176E	256	3.3	7.5	TQFP	176	128	E
	LC4256V-75T144E	256	3.3	7.5	TQFP	144	96	E
	LC4256V-75T100E	256	3.3	7.5	TQFP	100	64	E

## ispMACH 4000C (1.8V) Lead-Free Industrial Devices (Cont.)

Device	Part Number	Macrocells	Voltage	t <sub>PD</sub>	Package	Pin/Ball Count	I/O	Grade
LC4256C	LC4256C-5FTN256AI	256	1.8	5	Lead-free ftBGA	256	128	I
	LC4256C-75FTN256AI	256	1.8	7.5	Lead-free ftBGA	256	128	I
	LC4256C-10FTN256AI	256	1.8	10	Lead-free ftBGA	256	128	I
	LC4256C-5FTN256BI	256	1.8	5	Lead-free ftBGA	256	160	I
	LC4256C-75FTN256BI	256	1.8	7.5	Lead-free ftBGA	256	160	I
	LC4256C-10FTN256BI	256	1.8	10	Lead-free ftBGA	256	160	I
	LC4256C-5FN256AI <sup>1</sup>	256	1.8	5	Lead-free fpBGA	256	128	I
	LC4256C-75FN256AI <sup>1</sup>	256	1.8	7.5	Lead-free fpBGA	256	128	I
	LC4256C-10FN256AI <sup>1</sup>	256	1.8	10	Lead-free fpBGA	256	128	I
	LC4256C-5FN256BI <sup>1</sup>	256	1.8	5	Lead-free fpBGA	256	160	I
	LC4256C-75FN256BI <sup>1</sup>	256	1.8	7.5	Lead-free fpBGA	256	160	I
	LC4256C-10FN256BI <sup>1</sup>	256	1.8	10	Lead-free fpBGA	256	160	I
	LC4256C-5TN176I	256	1.8	5	Lead-free TQFP	176	128	I
	LC4256C-75TN176I	256	1.8	7.5	Lead-free TQFP	176	128	I
	LC4256C-10TN176I	256	1.8	10	Lead-free TQFP	176	128	I
	LC4256C-5TN100I	256	1.8	5	Lead-free TQFP	100	64	I
LC4256C-75TN100I	256	1.8	7.5	Lead-free TQFP	100	64	I	
LC4256C-10TN100I	256	1.8	10	Lead-free TQFP	100	64	I	
LC4384C	LC4384C-5FTN256I	384	1.8	5	Lead-free ftBGA	256	192	I
	LC4384C-75FTN256I	384	1.8	7.5	Lead-free ftBGA	256	192	I
	LC4384C-10FTN256I	384	1.8	10	Lead-free ftBGA	256	192	I
	LC4384C-5FN256I <sup>1</sup>	384	1.8	5	Lead-free fpBGA	256	192	I
	LC4384C-75FN256I <sup>1</sup>	384	1.8	7.5	Lead-free fpBGA	256	192	I
	LC4384C-10FN256I <sup>1</sup>	384	1.8	10	Lead-free fpBGA	256	192	I
	LC4384C-5TN176I	384	1.8	5	Lead-free TQFP	176	128	I
	LC4384C-75TN176I	384	1.8	7.5	Lead-free TQFP	176	128	I
LC4384C-10TN176I	384	1.8	10	Lead-free TQFP	176	128	I	
LC4512C	LC4512C-5FTN256I	512	1.8	5	Lead-free ftBGA	256	208	I
	LC4512C-75FTN256I	512	1.8	7.5	Lead-free ftBGA	256	208	I
	LC4512C-10FTN256I	512	1.8	10	Lead-free ftBGA	256	208	I
	LC4512C-5FN256I <sup>1</sup>	512	1.8	5	Lead-free fpBGA	256	208	I
	LC4512C-75FN256I <sup>1</sup>	512	1.8	7.5	Lead-free fpBGA	256	208	I
	LC4512C-10FN256I <sup>1</sup>	512	1.8	10	Lead-free fpBGA	256	208	I
	LC4512C-5TN176I	512	1.8	5	Lead-free TQFP	176	128	I
	LC4512C-75TN176I	512	1.8	7.5	Lead-free TQFP	176	128	I
LC4512C-10TN176I	512	1.8	10	Lead-free TQFP	176	128	I	

1. Use ftBGA package. fpBGA package devices have been discontinued via PCN#14A-07.